

MTA 100

TE Internal #: 643265-7

PCB Mount Header, Vertical, Wire-to-Board, 9 Position, 2.54 mm [.1

in] Centerline, Partially Shrouded, Tin, Through Hole - Solder,

Signal, MTA 100

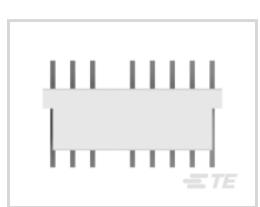
View on TE.com >



Connectors > PCB Connectors > PCB Headers & Receptacles > PCB Header: Polyester, Vertical, Unshrouded, No Mating Alignment











Connector System: Wire-to-Board

Number of Positions: 9

Number of Rows: 1

Centerline (Pitch): 2.54 mm [.1 in]
PCB Mount Orientation: Vertical

All PCB Header: Polyester, Vertical, Unshrouded, No Mating Alignment (134)

Features

Product Type Features

Connector System	Wire-to-Board
Header Type	Partially Shrouded
Sealable	No
Connector & Contact Terminates To	Printed Circuit Board
PCB Connector Assembly Type	PCB Mount Header

Configuration Features

Number of Columns	9
Number of Loaded Positions	8
Number of Positions	9
Number of Rows	1
PCB Mount Orientation	Vertical

Electrical Characteristics



Departing Voltage 250 VAC Body Features Primary Product Color Natural Contact Features Contact Mating Area Length 7.49 mm[.295 in] Mating Square Post Dimension .64 mm[.025 in] PCB Contact Termination Area Plating Material Thickness 3.81 µm[150 µin] Contact Layout Inline Contact Underplating Material Thickness 1.27 µm[50 µin] Contact Underplating Material Thickness 3.81 µm[150 µin] PCB Contact Termination Area Plating Material Finish Matte Contact Shape & Form Square Contact Mating Area Plating Material Finish Matte Contact Underplating Material Contact Underplating Material Nickel PCB Contact Termination Area Plating Material Tin Contact Base Material Copper Alloy Contact Mating Area Plating Material Tin Contact Type Pin Contact Current Rating (Max) 5 A
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Termination Features
Square Termination Post & Tail Dimension .64 mm[.025 in]
Termination Post & Tail Length 3.56 mm[.14 in]
Termination Method to Printed Circuit Board Through Hole - Solder
Mechanical Attachment
Mating Alignment Type Polarization
Mating Retention With
Panel Mount Feature Without
Mating Retention Type Friction Lock
Connector Mounting Type Board Mount
Mating Alignment With
PCB Mount Alignment Without
PCB Mount Retention Without



Housing Features

Housing Material	Polyester - GF
Centerline (Pitch)	2.54 mm[.1 in]

Dimensions

Connector Length	22.86 mm[.9 in]
Connector Height	10.03 mm[.395 in]
Connector Width	5.71 mm[.225 in]
PCB Thickness (Recommended)	1.6 mm[.063 in]

Usage Conditions

Operating Temperature Range	-55 – 105 °C[-67 – 221 °F]

Operation/Application

Circuit Application	Signal	
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Industry Standards

Agency/Standard	CSA, UL
Approved Standards	CSA LR7189, UL E28476
UL Flammability Rating	UL 94V-0

Packaging Features

Packaging Quantity	1
Packaging Type	Package

Other

Position Locations Omitted	6
Number of Blocked Positions	1

Product Compliance

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2023 (235) Candidate List Declared Against: JUNE 2023 (235) Does not contain REACH SVHC



Halogen Content	Not Low Halogen - contains Br or Cl > 900
	ppm.

Solder Process Capability

Wave solder capable to 265°C

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

Compatible Parts





TE Part # CAT-104MTA-NTPMR

Nylon Tin Plated Receptacle: 2.54 mm,
with Mating Alignment, MTA 100



mm, MTA 100



Also in the Series MTA 100









PCB Connector Keying(1)



PCB Headers & Receptacles(440)



Standard Rectangular Connectors(495)



Wire-to-Board Connector Assemblies & Housings(1)



Wire-to-Board Connector Contacts(8)



Customers Also Bought







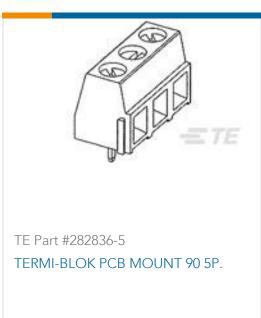














Documents

Product Drawings

09P MTA100 HDR ASSY W/O#6 STR

English

CAD Files

3D PDF

3D

Customer View Model

ENG_CVM_CVM_643265-7_Y.2d_dxf.zip

English

Customer View Model

ENG_CVM_CVM_643265-7_Y.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_643265-7_Y.3d_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use

PCB Mount Header, Vertical, Wire-to-Board, 9 Position, 2.54 mm [.1 in] Centerline, Partially Shrouded, Tin, Through Hole - Solder, Signal, MTA 100



Product Specifications

Application Specification

English

Agency Approvals

UL

English